# **OSRAM** LT T66G **Datasheet**





#### **TOPLED® Black**

# **LT T66G**

TOPLED Black is especially designed for variable message signs (VMS) and price changers. The black package offers premium contrast for display panels.





## **Applications**

- Projection & Display

#### **Features**

- Package: black PLCC-2 package, colorless resin

- Chip technology: UX:3

- Typ. Radiation: 60°

- Color:  $\lambda_{dom}$  = 532.0 nm (• true green)

- Corrosion Robustness Class: 3B

- Qualifications: AEC-Q102 Qualified

- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

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Luminous Intensity 1) Ordering Code Type  $I_{E} = 20 \text{ mA}$ 

LT T66G-DAEA-29-N424 4500 ... 9000 mcd Q65113A5369



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	$T_{op}$	min. max.	-40 °C 100 °C
Storage Temperature	$T_{stg}$	min. max.	-40 °C 100 °C
Junction Temperature	T <sub>j</sub>	max.	125 °C
Forward current T <sub>s</sub> = 25 °C	I <sub>F</sub>	min. max.	5 mA 50 mA
Surge current t $\leq$ 10 $\mu$ s; D = 0.1 ; T <sub>s</sub> = 25 °C	I <sub>FS</sub>	max.	300 mA
Reverse voltage <sup>2)</sup> T <sub>S</sub> = 25 °C	$V_R$	max.	5 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	$V_{ESD}$		2 kV



#### **Characteristics**

 $I_F$  = 20 mA;  $T_S$  = 25 °C

Parameter	Symbol	Values	
Peak Wavelength	$\lambda_{\sf peak}$	typ.	524.0 nm
Dominant Wavelength <sup>3)</sup> I <sub>F</sub> = 20 mA	λ <sub>dom</sub>	min. typ. max.	519.0 nm 532.0 nm 546.0 nm
Spectral Bandwidth at 50% I <sub>rel,max</sub>	$\Delta \lambda$	typ.	30.0 nm
Viewing angle at 50% $\rm I_{\rm v}$	2φ	typ.	55 °
Forward Voltage <sup>4)</sup> I <sub>F</sub> = 20 mA	$V_{\scriptscriptstyle F}$	min. typ. max.	2.20 V 2.70 V 3.00 V
Reverse current <sup>2)</sup> V <sub>R</sub> = 5 V	I <sub>R</sub>	typ. max.	0.01 μA 10 μA
Real thermal resistance junction/solderpoint 5)	R <sub>thJS real</sub>	max.	280 K / W



# **Brightness Groups**

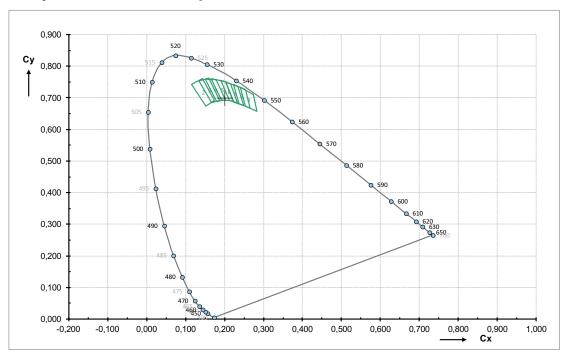
Group	Luminous Intensity <sup>1)</sup> $I_F = 20 \text{ mA}$ min. $I_V$	Luminous Intensity. 1)  I <sub>F</sub> = 20 mA  max.  I <sub>v</sub>	Luminous Flux $^{6)}$ I <sub>F</sub> = 20 mA typ. $\Phi_{V}$
DA	4500 mcd	5600 mcd	4970 mlm
DB	5600 mcd	7100 mcd	6250 mlm
EA	7100 mcd	9000 mcd	7920 mlm

# **Forward Voltage Groups**

Group	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 20 mA min. V <sub>F</sub>	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 20 mA max. V <sub>F</sub>	
N4	2.20 V	2.40 V	
S4	2.40 V	2.60 V	
W4	2.60 V	2.80 V	
24	2.80 V	3.00 V	



# **Chromaticity Coordinate Groups**



# **Chromaticity Coordinate Groups**

Group	Сх	Су	Group	Сх	Су	Group	Сх	Су
2	0.1150	0.7420	5	0.1660	0.7600	8	0.2220	0.7420
	0.1440	0.7600	-	0.2020	0.7520		0.2530	0.7270
	0.1740	0.6910	-	0.2220	0.6900		0.2650	0.6680
	0.1520	0.6730	-	0.1920	0.6940		0.2380	0.6810
3	0.1340	0.7540	6	0.1900	0.7550	9	0.2400	0.7340
	0.1600	0.7620	-	0.2150	0.7450		0.2740	0.7100
	0.1880	0.6920	-	0.2330	0.6840		0.2830	0.6570
	0.1670	0.6850	-	0.2120	0.6910		0.2540	0.6740
4	0.1500	0.7590	7	0.2030	0.7500			
	0.1790	0.7570	_	0.2340	0.7350			
	0.2020	0.6940	-	0.2490	0.6760			
	0.1800	0.6890	-	0.2220	0.6870			

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## **Group Name on Label**

Example: DA-2-24

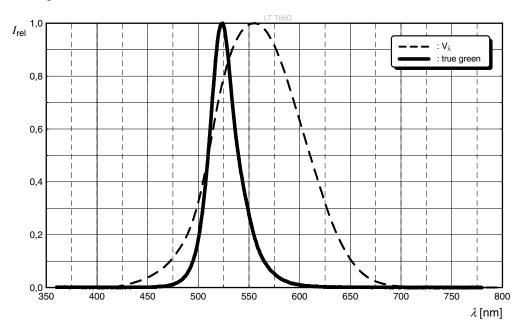
Brightness Color Chromaticity Forward Voltage

DA 2 24



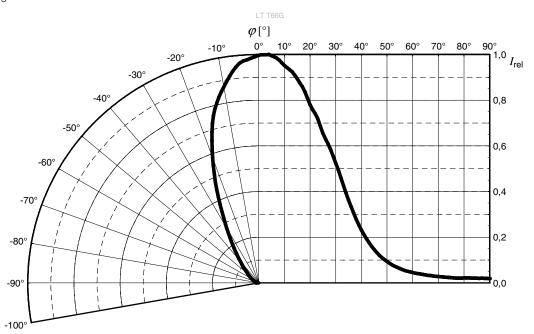
## Relative Spectral Emission 6)

 $I_{rel}$  = f ( $\lambda$ );  $I_{F}$  = 20 mA;  $T_{S}$  = 25 °C



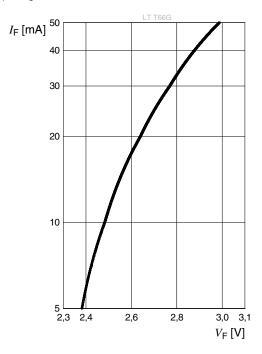
#### Radiation Characteristics 6)

 $I_{rel} = f(\phi); T_S = 25 °C$ 



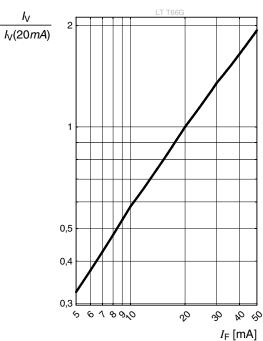
#### Forward current 6), 7)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



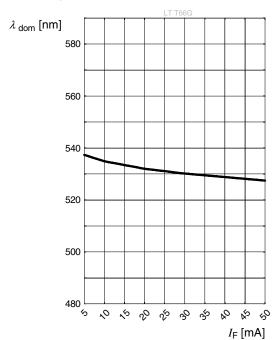
## Relative Luminous Intensity 6), 7)

$$I_{v}/I_{v}(20 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$



# Dominant Wavelength 6)

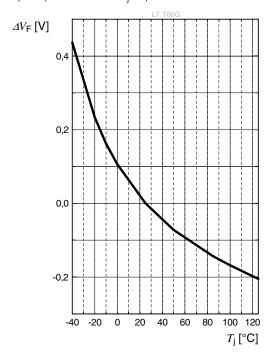
$$\lambda_{dom} = f(I_F); T_S = 25 \text{ }^{\circ}\text{C}$$





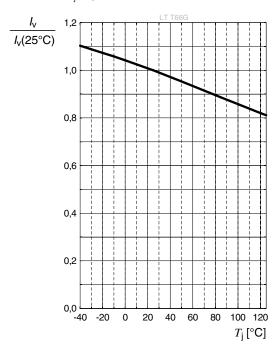
#### Forward Voltage 6)

$$\Delta V_F = V_F - V_F (25 \ ^{\circ}C) = f(T_j); I_F = 20 \ mA$$



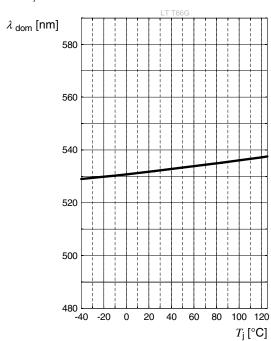
## Relative Luminous Intensity 6)

$$I_{v}/I_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 20 \text{ mA}$$



# Dominant Wavelength 6)

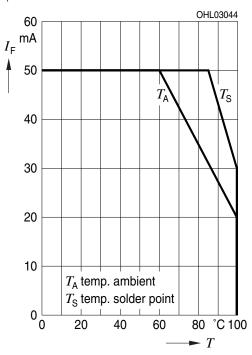
$$\lambda_{dom} = f(T_j); I_F = 20 \text{ mA}$$





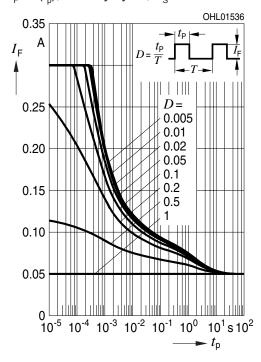
#### Max. Permissible Forward Current





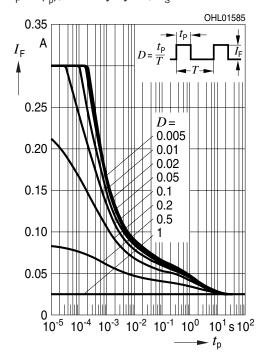
# Permissible Pulse Handling Capability

#### $I_{_{\rm F}}$ = f( $t_{_{ m D}}$ ); D: Duty cycle; $T_{_{ m S}}$ = 25 °C



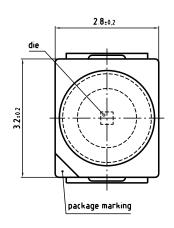
## Permissible Pulse Handling Capability

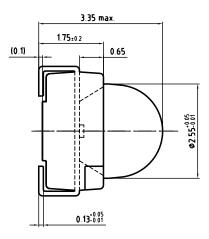
 $I_{_{\rm F}}$  = f(t $_{_{
m D}}$ ); D: Duty cycle;  $T_{_{
m S}}$  = 85 °C

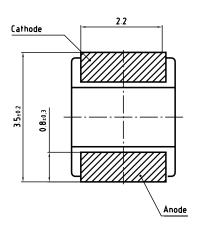




## **Dimensional Drawing** 8)







general tolerance ± 0.1 lead finish Ag

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#### **Further Information:**

**Approximate Weight:** 40.0 mg

Package marking: Anode

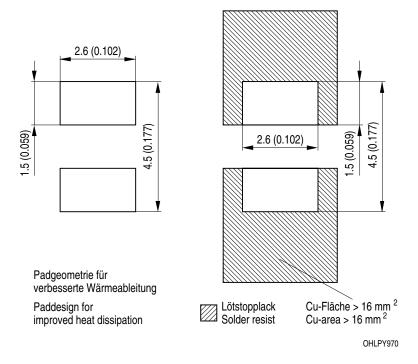
**Corrosion test:** Class: 3B

Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC

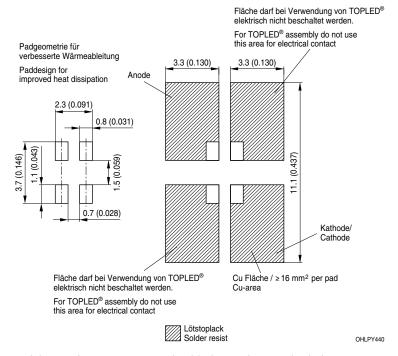
60068-2-43)



#### Recommended Solder Pad 8)



#### Recommended Solder Pad 8)

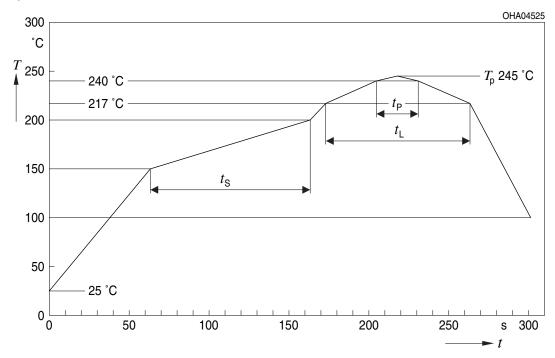


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.



#### **Reflow Soldering Profile**

Product complies to MSL Level 4 acc. to JEDEC J-STD-020E



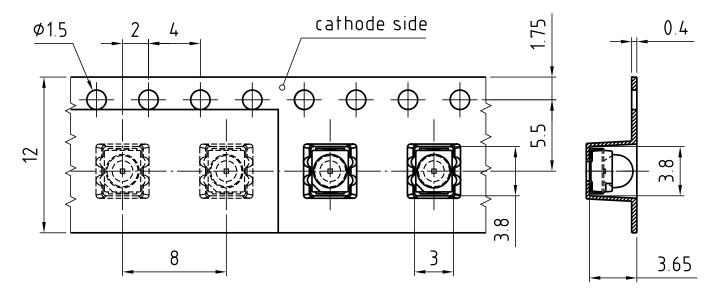
Profile Feature	Symbol	Pb-Free (S	Unit		
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)	'		2	3	K/s
25 °C to 150 °C					
Time t <sub>s</sub>	$t_s$	60	100	120	S
$T_{Smin}$ to $T_{Smax}$					
Ramp-up rate to peak*)			2	3	K/s
$T_{Smax}$ to $T_{P}$					
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle L}$		80	100	S
Peak temperature	$T_{P}$		245	250	°C
Time within 5 °C of the specified peak temperature T <sub>P</sub> - 5 K	t <sub>P</sub>	10	20	30	S
Ramp-down rate* T <sub>P</sub> to 100 °C			3	4	K/s
Time 25 °C to T <sub>P</sub>				480	S

All temperatures refer to the center of the package, measured on the top of the component

<sup>\*</sup> slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



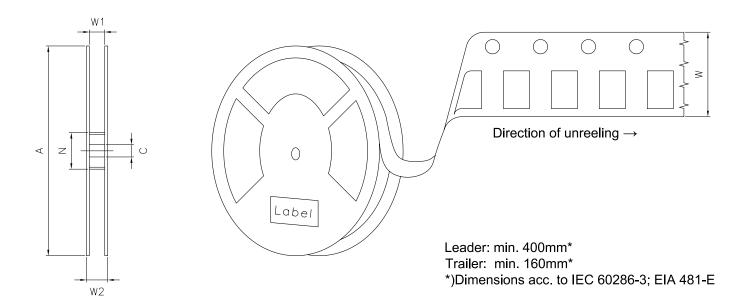
# Taping 8)



C67062-A0257-B9-01



## Tape and Reel 9)

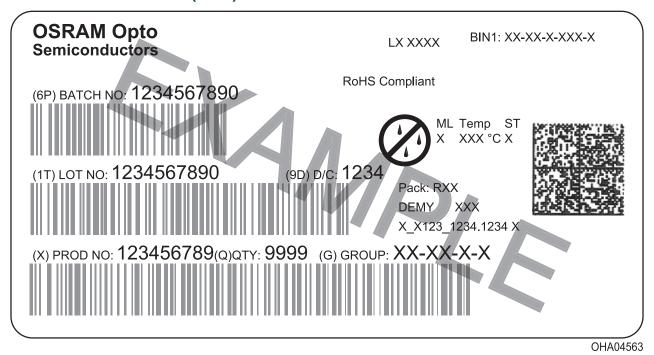


#### **Reel Dimensions**

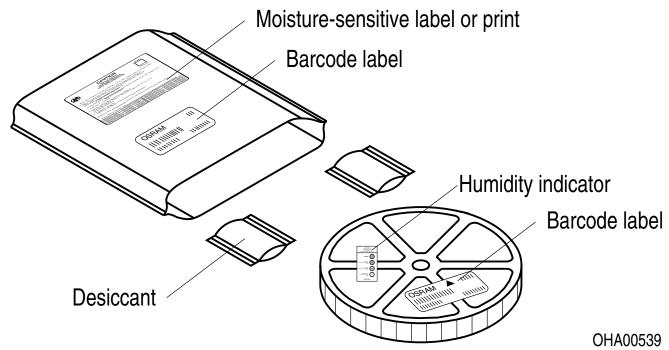
Α	W	$N_{\min}$	$W_1$	$W_{2\text{max}}$	Pieces per PU
330 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000



#### **Barcode-Product-Label (BPL)**



## Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

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#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



#### Disclaimer

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



#### **Glossary**

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k =
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 5) **Thermal Resistance:** Rth max is based on statistic values  $(6\sigma)$ .
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 9) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



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